General Description

The MAX220-MAX249 family of line drivers/receivers is intended for all EIA/TIA-232E and V.28/V.24 communications interfaces, particularly applications where ±12V is not available.

These parts are especially useful in battery-powered systems, since their low-power shutdown mode reduces power dissipation to less than 5µW. The MAX225, MAX233, MAX235, and MAX245/MAX246/MAX247 use no external components and are recommended for applications where printed circuit board space is critical.

Applications

Portable Computers

Low-Power Modems

Products. Inc.

- Interface Translation
- Battery-Powered RS-232 Systems

AutoShutdown and UCSP are trademarks of Maxim Integrated

Multidrop RS-232 Networks

Next-Generation Device Features

- ♦ For Low-Voltage, Integrated ESD Applications MAX3222E/MAX3232E/MAX3237E/MAX3241E/ MAX3246E: +3.0V to +5.5V, Low-Power, Up to 1Mbps, True RS-232 Transceivers Using Four 0.1µF External Capacitors (MAX3246E Available in a UCSP[™] Package)
- For Low-Cost Applications MAX221E: ±15kV ESD-Protected, +5V, 1µA, Single RS-232 Transceiver with AutoShutdown™

		mormation
PART	TEMP RANGE	PIN-PACKAGE
MAX220CPE+	0°C to +70°C	16 Plastic DIP
MAX220CSE+	0°C to +70°C	16 Narrow SO
MAX220CWE+	0°C to +70°C	16 Wide SO
MAX220C/D	0°C to +70°C	Dice*
MAX220EPE+	-40°C to +85°C	16 Plastic DIP
MAX220ESE+	-40°C to +85°C	16 Narrow SO
MAX220EWE+	-40°C to +85°C	16 Wide SO
MAX220EJE	-40°C to +85°C	16 CERDIP
MAX220MJE	-55°C to +125°C	16 CERDIP

+Denotes a lead(Pb)-free/RoHS-compliant package.

*Contact factory for dice specifications.

Ordering Information continued at end of data sheet.

Selection Table

Part	Power Supply	No. of RS-232	No. of	Nominal Cap. Value	SHDN & Three-	Rx Active in	Data Rate	
Number	(V)	Drivers/Rx	Ext. Caps	(µF)	State	SHDN	(kbps)	Features
MAX220	+5	2/2	4	0.047/0.33	No		120	Ultra-low-power, industry-standard pinout
MAX222	+5	2/2	4	0.1	Yes	_	200	Low-power shutdown
MAX223 (MAX213)	+5	4/5	4	1.0 (0.1)	Yes	~	120	MAX241 and receivers active in shutdown
MAX225	+5	5/5	0	_	Yes	~	120	Available in SO
MAX230 (MAX200)	+5	5/0	4	1.0 (0.1)	Yes	_	120	5 drivers with shutdown
MAX231 (MAX201)	+5 and +7.5 to +13.2	2/2	2	1.0 (0.1)	No	_	120	Standard +5/+12V or battery supplies; same functions as MAX232
MAX232 (MAX202)	+5	2/2	4	10(01)	No		120 (64)	Industry standard
VIANZSZ (IVIANZUZ) VIAX232A	+5	2/2	4	1.0 (0.1) 0.1	No	_	200 (64)	Higher slew rate, small caps
MAX232A MAX233 (MAX203)	+5	2/2	0		No		120	No external caps
VIAA233 (IVIAA203) VIAX233A	+5	2/2	0	_	No	_	200	No external caps, high slew rate
MAX233A MAX234 (MAX204)	+5	4/0	4	1.0 (0.1)	No	_	120	Replaces 1488
MAX235 (MAX204)		4/0 5/5	4	1.0 (0.1)	Yes	_	120	No external caps
MAX236 (MAX206)	+5	4/3	4	 1.0 (0.1)	Yes	_	120	Shutdown, three state
MAX230 (MAX200)	+5	4/3 5/3	4		No		120	·
- (-)		5/3 4/4	4	1.0 (0.1)	No	_	120	Complements IBM PC serial port Replaces 1488 and 1489
MAX238 (MAX208) MAX239 (MAX209)	+5 +5 and	4/4 3/5	4	1.0 (0.1)	No	_	120	
VIAA239 (IVIAA209)	+7.5 to +13.2	3/3	2	1.0 (0.1)	INO	_	120	Standard +5/+12V or battery supplies; single-package solution for IBM PC serial port
MAX240	+7.5 10 +13.2	E /E	4	1.0	Yes		120	
		5/5	4					DIP or flatpack package
MAX241 (MAX211) MAX242	+5	4/5	4 4	1.0 (0.1)	Yes	~	120 200	Complete IBM PC serial port
MAX242 MAX243	+5 +5	2/2	4	0.1	res No	•		Separate shutdown and enable
		2/2	-			_	200	Open-line detection simplifies cabling
MAX244	+5	8/10	4	1.0	No	_	120	High slew rate
MAX245	+5	8/10	0	_	Yes	~	120	High slew rate, int. caps, two shutdown modes
MAX246	+5	8/10	0		Yes	~	120	High slew rate, int. caps, three shutdown mode
MAX247	+5	8/9	0		Yes	~	120	High slew rate, int. caps, nine operating modes
MAX248	+5	8/8	4	1.0	Yes	~	120	High slew rate, selective half-chip enables
MAX249	+5	6/10	4	1.0	Yes	~	120	Available in quad flatpack package

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Ordering Information

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS-MAX220/222/232A/233A/242/243

(Voltages referenced to GND.)

V _{CC}	0.3V to +6V
V+ (Note 1)	(V _{CC} - 0.3V) to +14V
V- (Note 1)	+0.3V to -14V
Input Voltages	
ŤIN	0.3V to (V _{CC} - 0.3V)
RIN (Except MAX220)	±30V
RIN (MAX220)	±25V
TOUT (Except MAX220) (Note 2)	±15V
TOUT (MAX220)	±13.2V
Output Voltages	
ΤΟ'υΤ	
ROUT	
Driver/Receiver Output Short Circuited to	
Continuous Power Dissipation ($T_A = +70^{\circ}$)	
16-Pin Plastic DIP (derate 10.53mW/°C a	
18-Pin Plastic DIP (derate 11.11mW/°C a	
20-Pin Plastic DIP (derate 8.00mW/°C a	bove +70°C)440mW

16-Pin Narrow SO (derate 8.70mW/°C above +70°C)696mW 16-Pin Wide SO (derate 9.52mW/°C above +70°C)762mW 18-Pin Wide SO (derate 9.52mW/°C above +70°C)762mW 20-Pin Wide SO (derate 10.00mW/°C above +70°C)800mW
20-Pin SSOP (derate 8.00mW/°C above +70°C)
16-Pin CERDIP (derate 10.00mW/°C above +70°C)800mW
18-Pin CERDIP (derate 10.53mW/°C above +70°C)842mW
Operating Temperature Ranges
MAX2AC, MAX2C0°C to +70°C
MAX2AE, MAX2E40°C to +85°C
MAX2AM, MAX2M55°C to +125°C
Storage Temperature Range65°C to +160°C
Lead Temperature (soldering, 10s)+300°C
Soldering Temperature (reflow)
20 PDĬP (P2OM+1)+225°C
All other lead(Pb)-free packages+260°C
All other packages containing lead(Pb)+240°C

Note 1: For the MAX220, V+ and V- can have a maximum magnitude of 7V, but their absolute difference cannot exceed 13V. **Note 2:** Input voltage measured with TOUT in high-impedance state, V_{SHDN} or $V_{CC} = 0V$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—MAX220/222/232A/233A/242/243

 $(V_{CC} = +5V \pm 10\%, C1-C4 = 0.1\mu$ F, MAX220, C1 = 0.047 μ F, C2-C4 = 0.33 μ F, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 3)

PARAMETER	CONDITIONS			ТҮР	MAX	UNITS	
RS-232 TRANSMITTERS	•						
Output Voltage Swing	All transmitter output	its loaded with $3k\Omega$ to GND	±5	±8		V	
Input Logic-Low Voltage				1.4	0.8	V	
Input Logic-High Voltage	All devices except	MAX220	2	1.4		V	
Input Logic-High Voltage	MAX220: $V_{CC} = +5$.	OV	2.4			v	
	All except MAX220,	normal operation		5	40		
Logic Pullup/Input Current	V SHDN = 0V, MAX22 MAX220	2/MAX242, shutdown,		±0.01	±1	μA	
	$V_{CC} = +5.5V, V_{\overline{SHDN}} = 0V, V_{OUT} = \pm 15V,$ MAX222/MAX242			±0.01	±10		
Output Leakage Current		$V_{OUT} = \pm 15V$		±0.01	±10	μΑ	
	$V_{CC} = V_{SHDN} = 0V$	MAX220, $V_{OUT} = \pm 12V$			±25		
Data Rate				200	116	kbps	
Transmitter Output Resistance	$V_{\rm CC} = V_{\rm +} = V_{\rm -} = 0V_{\rm +}$	$V_{OUT} = \pm 2V$	300	10M		Ω	
Output Short-Circuit Current	Vout = 0V	V _{OUT} = 0V	±7	±22		mA	
Calput Short-Circuit Current	V001 = 0V	MAX220			±60		
RS-232 RECEIVERS							
RS-232 Input Voltage Operating Range					±30	v	
no-202 input voltage Operating hange		MAX220			±25	v	
RS-232 Input Threshold Low	$V_{CC} = +5V$	All except MAX243 R2IN	0.8	1.3		v	
	VUC - +3V	MAX243 R2IN (Note 4)	-3			v	
RS-232 Input Threshold High	$V_{CC} = +5V$	All except MAX243 R2IN		1.8	2.4	V	
		MAX243 R2IN (Note 4)		-0.5	-0.1	v	

ELECTRICAL CHARACTERISTICS—MAX220/222/232A/233A/242/243 (continued)

(V_{CC} = +5V ±10%, C1–C4 = 0.1µF, MAX220, C1 = 0.047µF, C2–C4 = 0.33µF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 3)

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS		
	All except MAX220/MAX243, V_{CC} = +5V, no hysteresis in shutdown				0.5	1.0	V	
RS-232 Input Hysteresis	MAX220				0.3			
	MAX243				1			
RS-232 Input Resistance	$T_{A} = +25^{\circ}C$ (N	MAX22	20)	3 3	5 5	7	kΩ	
	I _{OUT} = 3.2mA				0.2	0.4		
TTL/CMOS Output Voltage Low	I _{OUT} = 1.6mA	(MAX	220)			0.4	V	
TTL/CMOS Output Voltage High	I _{OUT} = -1.0mA	١		3.5	V _{CC} - 0.	2	V	
TTL/CMOS Output Short Circuit Current	Sourcing VOUT	r = VG	ND	-2	-10			
TTL/CMOS Output Short-Circuit Current	Sinking VOUT	= Vcc		10	30		mA	
TTL/CMOS Output Leakage Current	$V_{\overline{SHDN}} = V_{CC} O$ MAX222), OV \leq		= V_{CC} ($V_{\overline{SHDN}}$ = 0V for = $\leq V_{CC}$		±0.05	±10	μA	
EN Input Threshold Low	MAX242				1.4	0.8	V	
EN Input Threshold High	MAX242			2.0	1.4		V	
Supply Voltage Range						5.5	V	
		MAX	(220		0.5	2		
V _{CC} Supply Current (V <u>SHDN</u> = V _{CC}), Figures 5, 6, 11, 19	No load		(222/MAX232A/MAX233A/ (242/MAX243		4	10		
	3kΩ load both inputs MAX220 MAX222/MAX232A/MAX233A/ MAX242/MAX243			12		mA		
					15			
	Т,		= +25°C		0.1	10		
	MAX222/	T _A =	= 0°C to +70°C		2	50		
Shutdown Supply Current	MAX242 TA		-40°C to +85°C		2	50	μA	
			= -55°C to +125°C		35	100	1	
SHDN Input Leakage Current	MAX222/MAX	242				±1	μA	
SHDN Threshold Low	MAX222/MAX	242			1.4	0.8	V	
SHDN Threshold High	MAX222/MAX	242		2.0	1.4		V	
Transition Slew Rate	$C_L = 50 \text{pF to } 25$ $R_L = 3 \text{k} \Omega \text{ to } 7$ $V_{CC} = +5 \text{V}, \text{ Table}$	kΩ, \ =	MAX222/MAX232A/ MAX233/MAX242/MAX243	6	12	30	V/µs	
	+25°C, measured from +3V to -3V or -3V to +3V		MAX220	1.5	3	30.0	v/µs	
	t _{PHLT} , Figure 1		MAX222/MAX232A/ MAX233/MAX242/MAX243		1.3	3.5		
Transmitter Propagation Delay TLL to			MAX220		4	10]	
RS-232 (Normal Operation)	t _{PLHT} , Figure 1		MAX222/MAX232A/ MAX233/MAX242/MAX243		1.5	3.5	μs	
			MAX220		5	10		

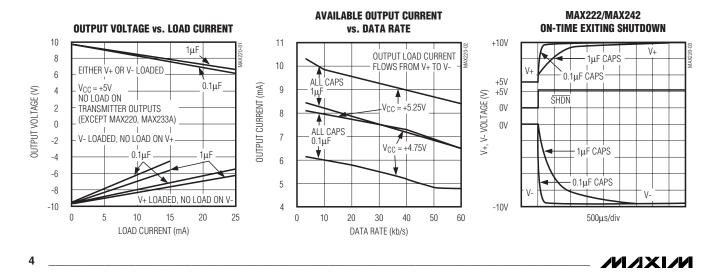
ELECTRICAL CHARACTERISTICS—MAX220/222/232A/233A/242/243 (continued)

(V_{CC} = +5V ±10%, C1–C4 = 0.1µF, MAX220, C1 = 0.047µF, C2–C4 = 0.33µF, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 3)

PARAMETER		CONDITIONS	MIN	ТҮР	MAX	UNITS	
	t _{PHLR} , Figure 2	MAX222/MAX232A/MAX233/ MAX242/MAX243		0.5	1		
Receiver Propagation Delay RS-232 to		MAX220		0.6	3	- µs	
TLL (Normal Operation)	t _{PLHR} , Figure 2	MAX222/MAX232A/MAX233/ MAX242/MAX243		0.6	1		
		MAX220		0.8	3]	
Receiver Propagation Delay RS-232 to	t _{PHLS} , Figure 2	MAX242		0.5	10		
TLL (Shutdown)	t _{PHLS} , Figure 2	MAX242		2.5 10		μs	
Receiver-Output Enable Time	t _{ER}	MAX242, Figure 3		125	500	ns	
Receiver-Output Disable Time	t _{DR}	MAX242, Figure 3		160	500	ns	
Transmitter-Output Enable Time (SHDN Goes High)	tet	MAX222/MAX242, 0.1µF caps (includes charge-pump start-up), Figure 4		250		μs	
Transmitter-Output Disable Time (SHDN Goes Low)	tot	MAX222/MAX242, 0.1µF caps, Figure 4		600		ns	
Transmitter + to - Propagation Delay Difference (Normal Operation)	tphlt - tplht	MAX222/MAX232A/MAX233/ MAX242/MAX243	300			ns	
		MAX220		2000			
Receiver + to - Propagation Delay Difference (Normal Operation)	tphlr - tplhr	MAX222/MAX232A/MAX233/ MAX242/MAX243	/ 100			ns	
		MAX220		225]	

Note 3: All units are production tested at hot. Specifications over temperature are guaranteed by design. **Note 4:** MAX243 R2OUT is guaranteed to be low when R2IN \ge 0V or is unconnected.

Typical Operating Characteristics



MAX220/MAX222/MAX232A/MAX233A/MAX242/MAX243

ABSOLUTE MAXIMUM RATINGS—MAX223/MAX230–MAX241

(Voltages referenced to GND.)	28-Pin V
V _{CC} 0.3V to +6V	44-Pin P
V+(V _{CC} - 0.3V) to +14V	14-Pin C
V+0.3V to -14V	16-Pin C
Input Voltages	20-Pin C
TIN0.3V to (V _{CC} + 0.3V)	24-Pin N
RIN±30V	
Output Voltages	24-Pin S
TOUT(V+ + 0.3V) to (V 0.3V)	28-Pin S
ROUT0.3V to (V _{CC} + 0.3V)	Operating
Short-Circuit Duration, TOUT to GNDContinuous	MAX2_
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	MAX2 _
14-Pin Plastic DIP (derate 10.00mW/°C above +70°C)800mW	MAX2 _
16-Pin Plastic DIP (derate 10.53mW/°C above +70°C)842mW	Storage T
20-Pin Plastic DIP (derate 11.11mW/°C above +70°C)889mW	Lead Ten
24-Pin Narrow Plastic DIP	Soldering
(derate 13.33mW/°C above +70°C)1.07W	20 PDIP
24-Pin Plastic DIP (derate 9.09mW/°C above +70°C)500mW	24 PDIP
16-Pin Wide SO (derate 9.52mW/°C above +70°C)762mW	All other
20-Pin Wide SO (derate 10.00mW/°C above +70°C)800mW	All other
24-Pin Wide SO (derate 11.76mW/°C above +70°C)941mW	

28-Pin Wide SO (derate 12.50mW/°C above +70°C)1W 14-Pin Plastic FP (derate 11.11mW/°C above +70°C)889mW 4-Pin CERDIP (derate 9.09mW/°C above +70°C)727mW 6-Pin CERDIP (derate 10.00mW/°C above +70°C)800mW 20-Pin CERDIP (derate 11.11mW/°C above +70°C)889mW 24-Pin Narrow CERDIP

(derate 12.50mW/°C above +70°C)1W
24-Pin Sidebraze (derate 20.0mW/°C above +70°C)1.6W
28-Pin SSOP (derate 9.52mW/°C above +70°C)762mW
Operating Temperature Ranges
MAX2 C0°C to +70°C
MAX2 E40°C to +85°C
MAX2 M55°C to +125°C
Storage Temperature Range65°C to +160°C
Lead Temperature (soldering, 10s)+300°C
Soldering Temperature (reflow)
20 PDIP (P20M+1)+225°C
24 PDIP (P24M-1)+225°C
All other lead(Pb)-free packages+260°C
All other packages containing lead(Pb)+240°C

MAX220-MAX249

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—MAX223/MAX230–MAX241

 $(MAX223/230/232/234/236/237/238/240/241, V_{CC} = +5V \pm 10\%; MAX233/MAX235, V_{CC} = +5V \pm 5\%, C1-C4 = 1.0\mu\text{F}; MAX231/MAX239, V_{CC} = +5V \pm 10\%; V_{+} = +7.5V \text{ to } +13.2V; T_{A} = T_{MIN} \text{ to } T_{MAX}; \text{ unless otherwise noted.}) (Note 5)$

PARAMETER		CONDITIONS			MAX	UNITS	
Output Voltage Swing	All transmitter	r outputs loaded with 3k Ω to ground	±5.0	±7.3		V	
		MAX232/233		5	10		
V _{CC} Supply Current	No load, $T_A = +25^{\circ}C$	MAX223/230/234-238/240/241		7	15	mA	
	14 - 120 0	MAX231/239		0.4	1	1	
V. Supply Current		MAX231		1.8	5	mA	
V+ Supply Current		MAX239		5	15		
		MAX223		15	50		
Shutdown Supply Current	$T_A = +25^{\circ}C$	MAX230/235/236/240/241		1	10	- μΑ	
Input Logic-Low Voltage	TIN, EN, SHD	HDN (MAX233); EN, SHDN (MAX230/235–241)			0.8	V	
	TIN		2.0				
Input Logic-High Voltage	EN, SHDN (M EN, SHDN (M	(MAX223); (MAX230/235/236/240/241)				V	
Logic Pullup Current	V _{TIN} = 0V			1.5	200	μA	
Receiver Input Voltage Operating Range			-30		+30	V	
	-						

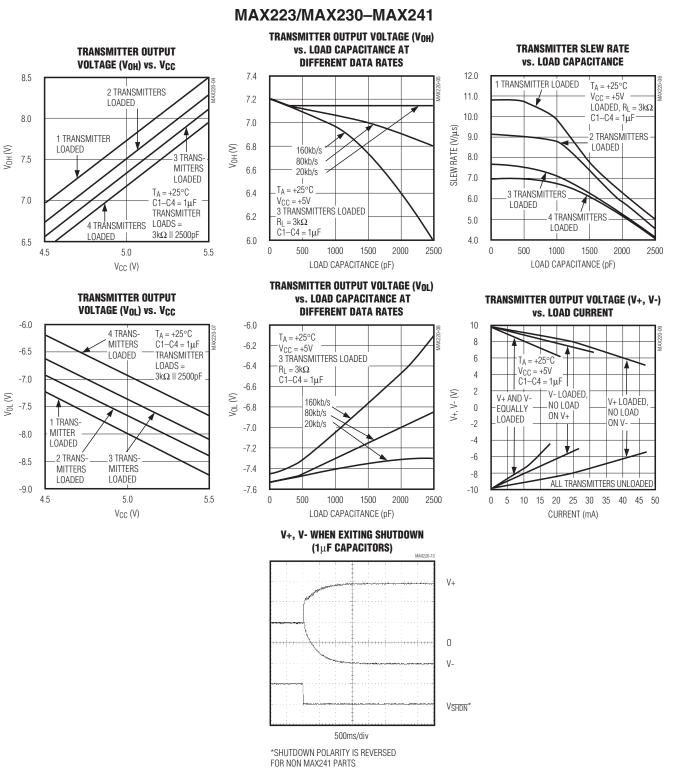
ELECTRICAL CHARACTERISTICS—MAX223/MAX230–MAX241 (continued)

 $(MAX223/230/232/234/236/237/238/240/241, V_{CC} = +5V \pm 10\%; MAX233/MAX235, V_{CC} = +5V \pm 5\%, C1-C4 = 1.0\mu\text{F}; MAX231/MAX239, V_{CC} = +5V \pm 10\%; V_{+} = +7.5V \text{ to } +13.2V; T_{A} = T_{MIN} \text{ to } T_{MAX}; \text{ unless otherwise noted.}) (Note 5)$

PARAMETER		CONDITIONS		MIN	ТҮР	MAX	UNITS
DS 222 Ipput Logic Low Veltage	$T_{A} = \pm 25^{\circ}C$		Normal operation $V_{SHDN} = +5V (MAX223)$ $V_{SHDN} = 0V (MAX235/236/240/241)$				v
RS-232 Input Logic-Low Voltage	$V_{CC} = +5V$	Shutdown (MAX22 $V_{\overline{SHDN}} = 0V,$ $V_{EN} = +5V$ (R4IN	,	0.6	1.5		
RS-232 Input Logic-High Voltage	T _A = +25°C,	Normal operation VSHDN = 5V (MA VSHDN = 0V (MA	X223) X235/236/240/241)		1.7	2.4	v
no-202 Input Logic-night voltage	$V_{CC} = +5V$	Shutdown (MAX223) V SHDN = 0V, V _{EN} = +5V (R4IN, R5IN)			1.5	2.4	
RS-232 Input Hysteresis	$V_{CC} = +5V$, no hy	ysteresis in shutdow	'n	0.2	0.5	1.0	V
RS-232 Input Resistance	$T_A = +25^{\circ}C, V_{CC} = +5V$				5	7	kΩ
TTL/CMOS Output Voltage Low	I _{OUT} = 1.6mA (MAX231/232/233, I _{OUT} = 3.2mA)					0.4	V
TTL/CMOS Output Voltage High	I _{OUT} = -1mA			3.5	V _{CC} - 0.4		V
TTL/CMOS Output Leakage Current	$\begin{array}{l} \text{OV} \leq \text{R}_{\text{OUT}} \leq \text{V}_{\text{CC}}; \text{V}_{\text{EN}} = \text{OV} \text{ (MAX223)}; \\ \text{V}_{\overline{\text{EN}}} = \text{V}_{\text{CC}} \text{ (MAX235-241)} \end{array}$				±0.05	±10	μA
Receiver Output Enable Time	Normal	MAX223			600		ns
	operation	operation MAX235/236/239/240/241			400		115
Receiver Output Disable Time	Normal	MAX223			900		- ns
neceiver Output Disable filme	operation	MAX235/236/239/2	240/241		250		115
	RS-232 IN to	BS-232 IN to Normal operation			0.5	10	
Propagation Delay	TTL/CMOS OUT,	V _{SHDN} = 0V	t _{PHLS}		4	40	μs
	$C_L = 150 pF$	(MAX223)	t _{PLHS}		6	40	1
Transition Dogion Claw Data	$\label{eq:max223} \begin{array}{l} \mbox{MAX223}/\mbox{MAX234}-241, \ \mbox{T}_{A} = +25^{\circ}\mbox{C}, \ \mbox{V}_{CC} = +5\mbox{V}, \\ \mbox{R}_{L} = 3\mbox{k}\Omega \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$		3	5.1	30	- V/µs	
Transition Region Slew Rate				4		v/µs	
Transmitter Output Resistance	$V_{CC} = V_{+} = V_{-} =$	$0V, V_{OUT} = \pm 2V$		300			Ω
Transmitter Output Short-Circuit Current					±10		mA

Note 5: All units are production tested at hot except for the MAX240, which is production tested at $T_A = +25^{\circ}C$. Specifications over temperature are guaranteed by design.

Typical Operating Characteristics



ABSOLUTE MAXIMUM RATINGS—MAX225/MAX244–MAX249

(Voltages referenced to GND.)	
Supply Voltage (V _{CC})	0.3V to +6V
Input Voltages	
TIN, ENA, ENB, ENR, ENT, ENRA,	
ENRE ENTA ENTE	-0.3V to (Vcc + 0.3V)

ENRB, ENTA, ENTB	0.3V to (V _{CC} + $0.3V$)
RIN	±25V
TOUT (Note 6)	±15V
ROUT	0.3V to (V _{CC} + 0.3V)
Short Circuit Duration (one output at a	time)
TOUT to GND	Continuous
ROUT to GND	Continuous

Continuous Power Dissipation ($T_A = +70^{\circ}C$) 28-Pin Wide SO (derate 12.50mW/°C above +70°C 40-Pin Plastic DIP (derate 11.11mW/°C above +70°C) 44-Pin PLCC (derate 13.33mW/°C above +70°C))°C)611mW
Operating Temperature Ranges	
MAX225C, MAX24_C	0°C to +70°C
MAX225E, MAX24_E4	0°C to +85°C
Storage Temperature Range65	5°C to +160°C
Lead Temperature (soldering, 10s))	+300°C
Soldering Temperature (reflow)	
40 PDIP (P40M-2)	+225°C
All other lead(Pb)-free packages	
All other packages containing lead(Pb)	+240°C

Note 6: Input voltage measured with transmitter output in a high-impedance state, shutdown, or V_{CC} = 0V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—MAX225/MAX244–MAX249

(MAX225, V_{CC} = +5.0V ±5%; MAX244–MAX249, V_{CC} = +5.0V ±10%, external capacitors C1–C4 = 1µF; T_A = T_{MIN} to T_{MAX}; unless otherwise noted.) (Note 7)

PARAMETER	CONDITIONS			ТҮР	MAX	UNITS
RS-232 TRANSMITTERS			1		ı	
Input Logic-Low Voltage				1.4	0.8	V
Input Logic-High Voltage			2	1.4		V
Logic Pullup/Input Current	Tables 1a-1d	Normal operation		10	50	
Logic Fullup/Input Current		Shutdown		±0.01	±1	μΑ
Data Rate	Tables 1a-1d, r	normal operation		120	64	kbps
Output Voltage Swing	All transmitter o	utputs loaded with 3k Ω to GND	±5	±7.5		V
Output Lookogo Ourgent (Chutdown)	Tables 1a-1d	VENA, VENB, VENT, VENTA, VENTB = VCC, VOUT = ±15V		±0.01	±25	0
Output Leakage Current (Shutdown)		$V_{CC} = 0V,$ $V_{OUT} = \pm 15V$		±0.01	±25	μΑ
Transmitter Output Resistance	$V_{CC} = V_{+} = V_{-} = 0V, V_{OUT} = \pm 2V$ (Note 8)		300	10M		Ω
Output Short-Circuit Current	V _{OUT} = 0V		±7	±30		mA
RS-232 RECEIVERS	1					
RS-232 Input Voltage Operating Range					±25	V
RS-232 Input Logic-Low Voltage	$V_{CC} = +5V$		0.8	1.3		V
RS-232 Input Logic-High Voltage	$V_{\rm CC} = +5V$			1.8	2.4	V
RS-232 Input Hysteresis	$V_{\rm CC} = +5V$		0.2	0.5	1.0	V
RS-232 Input Resistance			3	5	7	kΩ
TTL/CMOS Output Voltage Low	$I_{OUT} = 3.2 \text{mA}$			0.2	0.4	V
TTL/CMOS Output Voltage High	I _{OUT} = -1.0mA			V _{CC} - 0.2		V
TTL/CMOS Output Short-Circuit Current	Sourcing V _{OUT} = V _{GND}		-2	-10		
TE/GWOS Output Short-Circuit Current	Sinking V _{OUT} = V _{CC}			30		mA
TTL/CMOS Output Leakage Current		on, outputs disabled, $0V \le V_{OUT} \le V_{CC}, V_{\overline{ENR}} = V_{CC}$		±0.05	±0.10	μΑ



ELECTRICAL CHARACTERISTICS—MAX225/MAX244–MAX249 (continued)

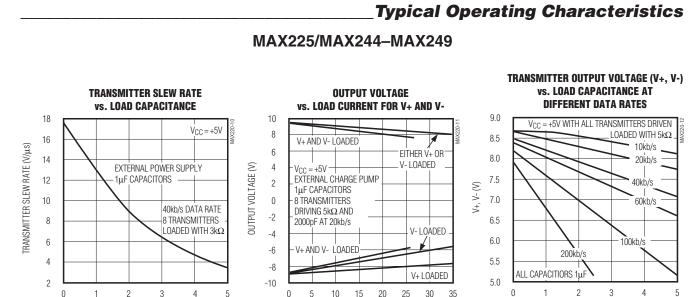
(MAX225, V_{CC} = +5.0V ±5%; MAX244–MAX249, V_{CC} = +5.0V ±10%, external capacitors C1–C4 = 1 μ F; T_A = T_{MIN} to T_{MAX}; unless otherwise noted.) (Note 7)

PARAMETER	CONDITIONS			TYP	MAX	UNITS	
POWER SUPPLY AND CONTROL LC	GIC						
		MAX225	4.75		5.25		
Supply Voltage Range		MAX244-MAX249	4.5		5.5	V	
		MAX225		10	20		
V _{CC} Supply Current	No load	MAX244-MAX249		11	30		
(Normal Operation)	$3k\Omega$ loads on	MAX225		40		mA	
	all outputs	MAX244-MAX249		57			
Chutdown Cunolly Current	$T_A = +25^{\circ}C$			8	25		
Shutdown Supply Current	$T_A = T_{MIN}$ to T_I	MAX			50	μA	
	Leakage curre	nt			±1	μA	
Control Input	Logic-low volta	age		1.4	0.8	V	
	Logic-high volt	age	2.4	1.4			
AC CHARACTERISTICS							
Transition Slew Rate		500pF, R _L = $3k\Omega$ to $7k\Omega$, V _{CC} = +5V, easured from +3V to -3V or -3V to +3V	5	10	30	V/µs	
Transmitter Propagation Delay	t _{PHLT} , Figure 1			1.3	3.5	μs	
TLL to RS-232 (Normal Operation)	t _{PLHT} , Figure 1		1.5	3.5	μο		
Receiver Propagation Delay	t _{PHLR} , Figure 2		0.6	1.5	μs		
TLL to RS-232 (Normal Operation)	t _{PLHR} , Figure 2		0.6	1.5	μο		
Receiver Propagation Delay	t _{PHLS} , Figure 2		0.6	10			
TLL to RS-232 (Low-Power Mode)	t _{PLHS} , Figure 2			3.0	10	μs	
Transmitter + to - Propagation Delay Difference (Normal Operation)	tphlt - tplht			350		ns	
Receiver + to - Propagation Delay Difference (Normal Operation)	tphlr - tplhr			350		ns	
Receiver-Output Enable Time	t _{ER} , Figure 3			100	500	ns	
Receiver-Output Disable Time	t _{DR} , Figure 3			100	500	ns	
Tropposition English Time		MAX246–MAX249 (excludes charge-pump startup)		5		μs	
Transmitter Enable Time	tet	MAX225/MAX245–MAX249 (includes charge-pump startup)		10		ms	
Transmitter Disable Time	t _{DT} , Figure 4			100		ns	

Note 7: All units production tested at hot. Specifications over temperature are guaranteed by design.

Note 8: The 300Ω minimum specification complies with EIA/TIA-232E, but the actual resistance when in shutdown mode or V_{CC} = 0V is $10M\Omega$ as is implied by the leakage specification.

LOAD CAPACITANCE (nF)



LOAD CURRENT (mA)



tPHLS

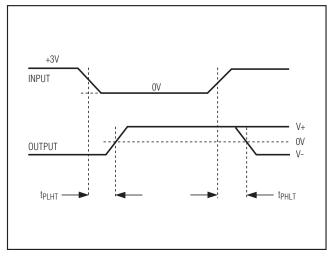


Figure 1. Transmitter Propagation-Delay Timing

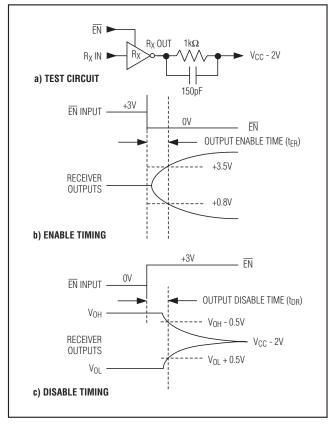


Figure 3. Receiver-Output Enable and Disable Timing

Test Circuits/Timing Diagrams

*EXCEPT FOR R2 ON THE MAX243 WHERE -3V IS USED.

Figure 2. Receiver Propagation-Delay Timing

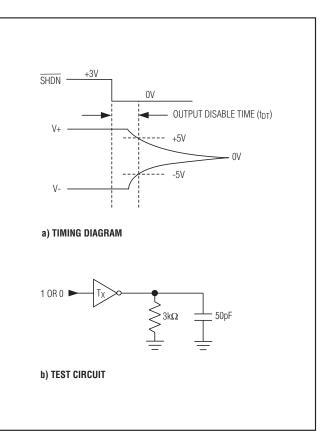


Figure 4. Transmitter-Output Disable Timing

tPLHS

Control Pin Configuration Tables

Table 1a. MAX245 Control Pin Configurations

ENT	ENR	OPERATION STATUS	TRANSMITTERS	RECEIVERS
0	0	Normal Operation	All Active	All Active
0	1	Normal Operation	All Active	All High-Z
1	0	Shutdown	All High-Z	All Low-Power Receive Mode
1	1	Shutdown	All High-Z	All High-Z

Table 1b. MAX245 Control Pin Configurations

ENT	ENR	OPERATION	OPERATION TRANSMITTERS			EIVERS
		STATUS	TA1–TA4	TB1–TB4	RA1–RA5	RB1–RB5
0	0	Normal Operation	All Active	All Active	All Active	All Active
0	1	Normal Operation	All Active	All Active	RA1–RA4 High-Z, RA5 Active	RB1–RB4 High-Z, RB5 Active
1	0	Shutdown	All High-Z	All High-Z	All Low-Power Receive Mode	All Low-Power Receive Mode
1	1	Shutdown	All High-Z	All High-Z	RA1–RA4 High-Z, RA5 Low-Power Receive Mode	RB1–RB4 High-Z, RB5 Low-Power Receive Mode

Table 1c. MAX246 Control Pin Configurations

ENA	ENB	OPERATION	OPERATION TRANSMITTERS		RECE	IVERS
ENA	LIND	STATUS	TA1–TA4	TB1–TB4	RA1–RA5	RB1–RB5
0	0	Normal Operation	All Active	All Active	All Active	All Active
0	1	Normal Operation	All Active	All High-Z	All Active	RB1–RB4 High-Z, RB5 Active
1	0	Shutdown	All High-Z	All Active	RA1–RA4 High-Z, RA5 Active	All Active
1	1	Shutdown	All High-Z	All High-Z	RA1–RA4 High-Z, RA5 Low-Power Receive Mode	RB1–RB4 High-Z, RA5 Low-Power Receive Mode

						TRANS	/ITTERS	REC	EIVERS
ENTA	ENTB	ENRA	ENRB	OPERATION	MAX247	TA1–TA4	TB1–TB4	RA1–RA4	RB1–RB5
ENIA	ENIB	ENKA	ENKB	STATUS	MAX248	TA1–TA4	TB1–TB4	RA1–RA4	RB1–RB4
					MAX249	TA1–TA3	TB1–TB3	RA1–RA5	RB1–RB5
0	0	0	0	Normal Operation		All Active	All Active	All Active	All Active
0	0	0	1	Normal Operation		All Active	All Active	All Active	All High-Z, except RB5 stays active on MAX247
0	0	1	0	Normal Operation		All Active	All Active	All High-Z	All Active
0	0	1	1	Normal Operation		All Active	All Active	All High-Z	All High-Z, except RB5 stays active on MAX247
0	1	0	0	Normal Operation		All Active	All High-Z	All Active	All Active
0	1	0	1	Normal Operation		All Active	All High-Z	All Active	All High-Z, except RB5 stays active on MAX247
0	1	1	0	Normal Operation		All Active	All High-Z	All High-Z	All Active
0	1	1	1	Normal Operation		All Active	All High-Z	All High-Z	All High-Z, except RB5 stays active on MAX247
1	0	0	0	Normal Operation		All High-Z	All Active	All Active	All Active
1	0	0	1	Normal Operation		All High-Z	All Active	All Active	All High-Z, except RB5 stays active on MAX247
1	0	1	0	Normal Operation		All High-Z	All Active	All High-Z	All Active
1	0	1	1	Normal Operation		All High-Z	All Active	All High-Z	All High-Z, except RB5 stays active on MAX247
1	1	0	0	Shutdown		All High-Z	All High-Z	Low-Power Receive Mode	Low-Power Receive Mode
1	1	0	1	Shutdown		All High-Z	All High-Z	Low-Power Receive Mode	All High-Z, except RB5 stays active on MAX247
1	1	1	0	Shutdown		All High-Z	All High-Z	All High-Z	Low-Power Receive Mode
1	1	1	1	Shutdown		All High-Z	All High-Z	All High-Z	All High-Z, except RB5 stays active on MAX247

Table 1d. MAX247/MAX248/MAX249 Control Pin Configurations

WAX220-MAX249

Detailed Description

The MAX220–MAX249 contain four sections: dual charge-pump DC-DC voltage converters, RS-232 drivers, RS-232 receivers, and receiver and transmitter enable control inputs.

Dual Charge-Pump Voltage Converter The MAX220–MAX249 have two internal charge-pumps that convert +5V to ±10V (unloaded) for RS-232 driver operation. The first converter uses capacitor C1 to double the +5V input to +10V on C3 at the V+ output. The second converter uses capacitor C2 to invert +10V to -10V on C4 at the V- output.

A small amount of power may be drawn from the +10V (V+) and -10V (V-) outputs to power external circuitry (see the *Typical Operating Characteristics* section), except on the MAX225 and MAX245–MAX247, where these pins are not available. V+ and V- are not regulated, so the output voltage drops with increasing load current. Do not load V+ and V- to a point that violates the minimum \pm 5V EIA/TIA-232E driver output voltage when sourcing current from V+ and V- to external circuitry.

When using the shutdown feature in the MAX222, MAX225, MAX230, MAX235, MAX236, MAX240, MAX241, and MAX245–MAX249, avoid using V+ and Vto power external circuitry. When these parts are shut down, V- falls to 0V, and V+ falls to +5V. For applications where a +10V external supply is applied to the V+ pin (instead of using the internal charge pump to generate +10V), the C1 capacitor must not be installed and the SHDN pin must be connected to V_{CC}. This is because V+ is internally connected to V_{CC} in shutdown mode.

RS-232 Drivers

The typical driver output voltage swing is ±8V when loaded with a nominal 5k Ω RS-232 receiver and V_{CC} = +5V. Output swing is guaranteed to meet the EIA/TIA-232E and V.28 specification, which calls for ±5V minimum driver output levels under worst-case conditions. These include a minimum 3k Ω load, V_{CC} = +4.5V, and maximum operating temperature. Unloaded driver output voltage ranges from (V+ -1.3V) to (V- +0.5V).

Input thresholds are both TTL and CMOS compatible. The inputs of unused drivers can be left unconnected since $400k\Omega$ input pullup resistors to V_{CC} are built in (except for the MAX220). The pullup resistors force the outputs of unused drivers low because all drivers invert. The internal input pullup resistors typically source 12µA, except in shutdown mode where the pullups are disabled. Driver outputs turn off and enter a high-impedance state—where leakage current is typically microamperes (maximum 25µA)—when in shutdown

mode, in three-state mode, or when device power is removed. Outputs can be driven to $\pm 15V$. The power-supply current typically drops to 8µA in shutdown mode. The MAX220 does not have pullup resistors to force the outputs of the unused drivers low. Connect unused inputs to GND or V_{CC}.

The MAX239 has a receiver three-state control line, and the MAX223, MAX225, MAX235, MAX236, MAX240, and MAX241 have both a receiver three-state control line and a low-power shutdown control. Table 2 shows the effects of the shutdown control and receiver threestate control on the receiver outputs.

The receiver TTL/CMOS outputs are in a high-impedance, three-state mode whenever the three-state enable line is high (for the MAX225/MAX235/MAX236/MAX239– MAX241), and are also high-impedance whenever the shutdown control line is high.

When in low-power shutdown mode, the driver outputs are turned off and their leakage current is less than 1µA with the driver output pulled to ground. The driver output leakage remains less than 1µA, even if the transmitter output is backdriven between 0V and (V_{CC} + 6V). Below -0.5V, the transmitter is diode clamped to ground with 1k Ω series impedance. The transmitter is also zener clamped to approximately V_{CC} + 6V, with a series impedance of 1k Ω .

The driver output slew rate is limited to less than 30V/µs as required by the EIA/TIA-232E and V.28 specifications. Typical slew rates are 24V/µs unloaded and 10V/µs loaded with 3Ω and 2500pF.

RS-232 Receivers

EIA/TIA-232E and V.28 specifications define a voltage level greater than 3V as a logic 0, so all receivers invert. Input thresholds are set at 0.8V and 2.4V, so receivers respond to TTL level inputs as well as EIA/TIA-232E and V.28 levels.

The receiver inputs withstand an input overvoltage up to $\pm 25V$ and provide input terminating resistors with

Table 2. Three-State Control of Receivers

PART	SHDN	SHDN	EN	EN(R)	RECEIVERS
MAX223		Low High High	X Low High	_	High Impedance Active High Impedance
MAX225				Low High	High Impedance Active
MAX235 MAX236 MAX240	Low Low High			Low High X	High Impedance Active High Impedance



MAX220-MAX249

+5V-Powered, Multichannel RS-232 Drivers/Receivers

nominal 5k Ω values. The receivers implement Type 1 interpretation of the fault conditions of V.28 and EIA/TIA-232E.

The receiver input hysteresis is typically 0.5V with a guaranteed minimum of 0.2V. This produces clear output transitions with slow-moving input signals, even with moderate amounts of noise and ringing. The receiver propagation delay is typically 600ns and is independent of input swing direction.

Low-Power Receive Mode

The low-power receive mode feature of the MAX223, MAX242, and MAX245–MAX249 puts the IC into shutdown mode but still allows it to receive information. This is important for applications where systems are periodically awakened to look for activity. Using low-power receive mode, the system can still receive a signal that will activate it on command and prepare it for communication at faster data rates. This operation conserves system power.

Negative Threshold—MAX243

The MAX243 is pin compatible with the MAX232A, differing only in that RS-232 cable fault protection is removed on one of the two receiver inputs. This means that control lines such as CTS and RTS can either be driven or left unconnected without interrupting communication. Different cables are not needed to interface with different pieces of equipment.

The input threshold of the receiver without cable fault protection is -0.8V rather than +1.4V. Its output goes positive only if the input is connected to a control line that is actively driven negative. If not driven, it defaults to the 0 or "OK to send" state. Normally, the MAX243's other receiver (+1.4V threshold) is used for the data line (TD or RD), while the negative threshold receiver is connected to the control line (DTR, DTS, CTS, RTS, etc.).

Other members of the RS-232 family implement the optional cable fault protection as specified by EIA/TIA-232E specifications. This means a receiver output goes high whenever its input is driven negative, left unconnected, or shorted to ground. The high output tells the serial communications IC to stop sending data. To avoid this, the control lines must either be driven or connected with jumpers to an appropriate positive voltage level.

Shutdown—MAX222-MAX242

On the MAX222, MAX235, MAX236, MAX240, and MAX241, all receivers are disabled during shutdown. On the MAX223 and MAX242, two receivers continue to operate in a reduced power mode when the chip is in shutdown. Under these conditions, the propagation delay increases to about 2.5µs for a high-to-low input transition. When in shutdown, the receiver acts as a CMOS inverter with no hysteresis. The MAX223 and MAX242 also have a receiver output enable input (EN for the MAX242 and EN for the MAX223) that allows receiver output control independent of SHDN (SHDN for MAX241). With all other devices, SHDN (SHDN for MAX241) also disables the receiver outputs.

The MAX225 provides five transmitters and five receivers, while the MAX245 provides ten receivers and eight transmitters. Both devices have separate receiver and transmitter-enable controls. The charge pumps turn off and the devices shut down when a logic high is applied to the ENT input. In this state, the supply current drops to less than 25µA and the receivers continue to operate in a low-power receive mode. Driver outputs enter a high-impedance state (three-state mode). On the MAX225, all five receivers are controlled by the ENR input. On the MAX245, eight of the receiver outputs are controlled by the ENR input, while the remaining two receivers (RA5 and RB5) are always active. RA1–RA4 and RB1–RB4 are put in a three-state mode when ENR is a logic high.

Receiver and Transmitter Enable Control Inputs

The MAX225 and MAX245–MAX249 feature transmitter and receiver enable controls.

The receivers have three modes of operation: full-speed receive (normal active), three-state (disabled), and low-power receive (enabled receivers continue to function at lower data rates). The receiver enable inputs control the full-speed receive and three-state modes. The transmitters have two modes of operation: full-speed transmit (normal active) and three-state (disabled). The transmitter enable inputs also control the shutdown mode. The device enters shutdown mode when all transmitters are disabled. Enabled receivers function in the low-power receive mode when in shutdown.

Tables 1a–1d define the control states. The MAX244 has no control pins and is not included in these tables.

The MAX246 has ten receivers and eight drivers with two control pins, each controlling one side of the device. A logic high at the A-side control input ($\overline{\text{ENA}}$) causes the four A-side receivers and drivers to go into a three-state mode. Similarly, the B-side control input ($\overline{\text{ENB}}$) causes the four B-side drivers and receivers to go into a three-state mode. As in the MAX245, one Aside and one B-side receiver (RA5 and RB5) remain active at all times. The entire device is put into shutdown mode when both the A and B sides are disabled ($\overline{\text{ENA}} = \overline{\text{ENB}} = +5\text{V}$).

The MAX247 provides nine receivers and eight drivers with four control pins. The ENRA and ENRB receiver enable inputs each control four receiver outputs. The ENTA and ENTB transmitter enable inputs each control four drivers. The ninth receiver (RB5) is always active. The device enters shutdown mode with a logic high on both ENTA and ENTB.

The MAX248 provides eight receivers and eight drivers with four control pins. The ENRA and ENRB receiver enable inputs each control four receiver outputs. The ENTA and ENTB transmitter enable inputs control four drivers each. This part does not have an always-active receiver. The device enters shutdown mode and transmitters go into a three-state mode with a logic high on both ENTA and ENTB.

The MAX249 provides ten receivers and six drivers with four control pins. The ENRA and ENRB receiver enable inputs each control five receiver outputs. The ENTA and ENTB transmitter enable inputs control three drivers each. There is no always-active receiver. The device enters shutdown mode and transmitters go into a three-state mode with a logic high on both ENTA and ENTB. In shutdown mode, active receivers operate in a low-power receive mode at data rates up to 20kb/s.

Applications Information

Figures 5 through 25 show pin configurations and typical operating circuits. In applications that are sensitive to power-supply noise, V_{CC} should be decoupled to ground with a capacitor of the same value as C1 and C2 connected as close as possible to the device.

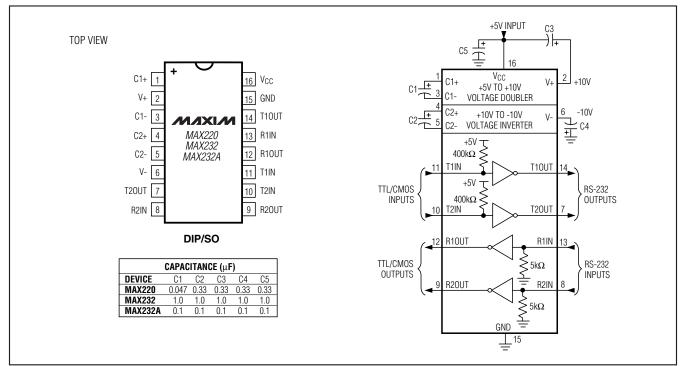


Figure 5. MAX220/MAX232/MAX232A Pin Configuration and Typical Operating Circuit

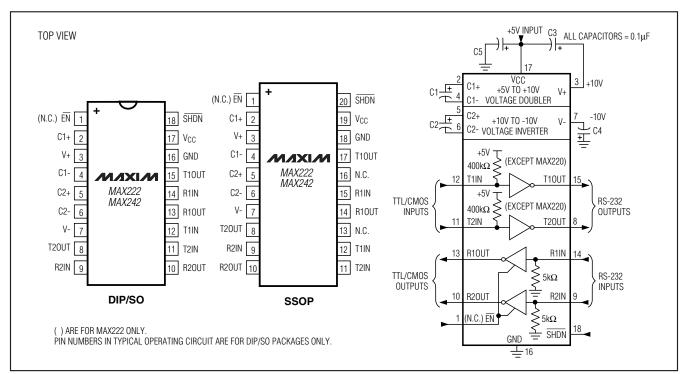


Figure 6. MAX222/MAX242 Pin Configurations and Typical Operating Circuit

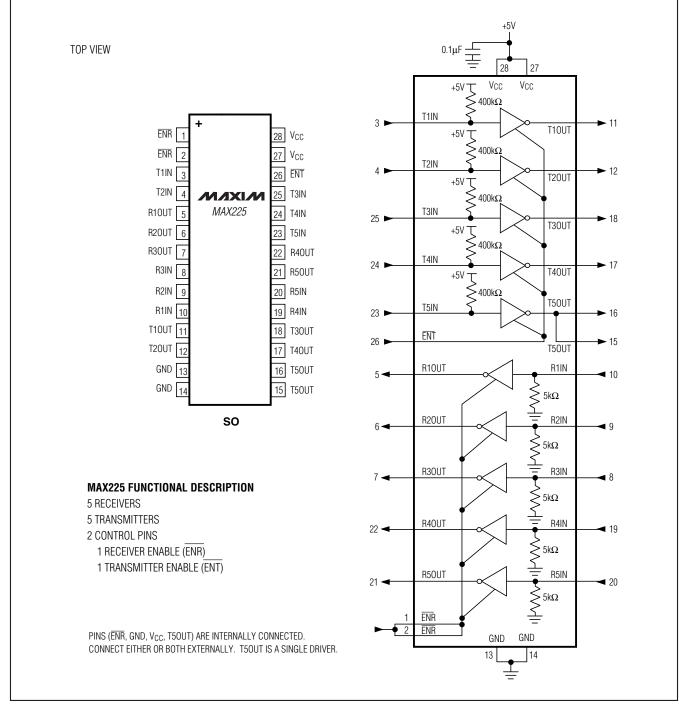


Figure 7. MAX225 Pin Configuration and Typical Operating Circuit

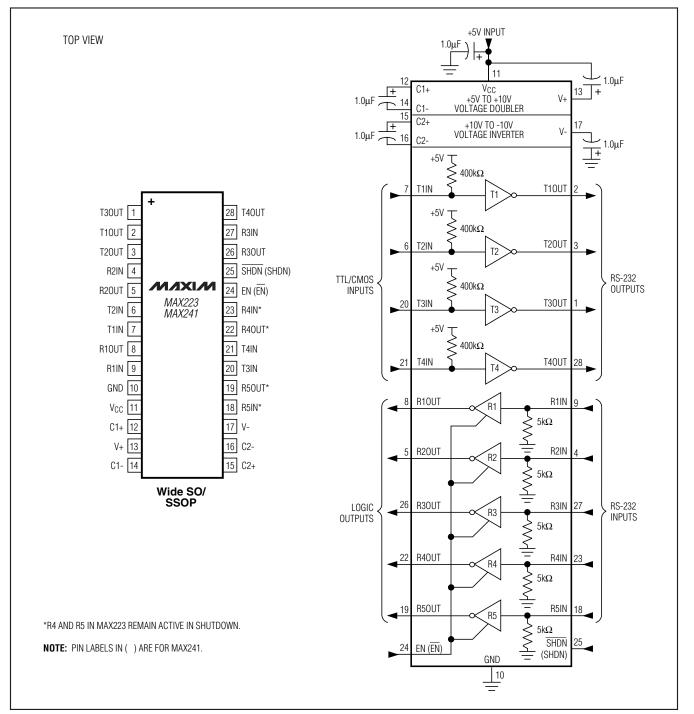


Figure 8. MAX223/MAX241 Pin Configuration and Typical Operating Circuit

M/X/M

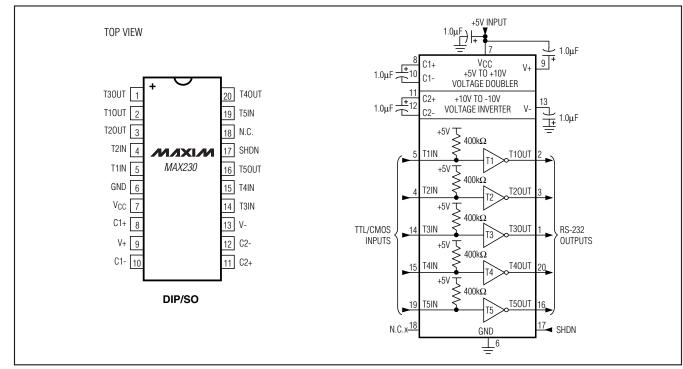


Figure 9. MAX230 Pin Configuration and Typical Operating Circuit

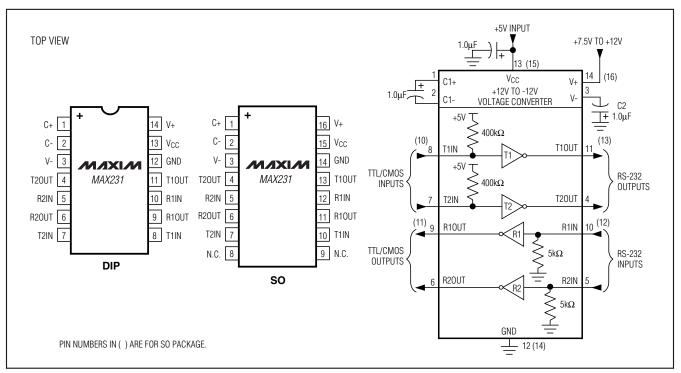


Figure 10. MAX231 Pin Configurations and Typical Operating Circuit



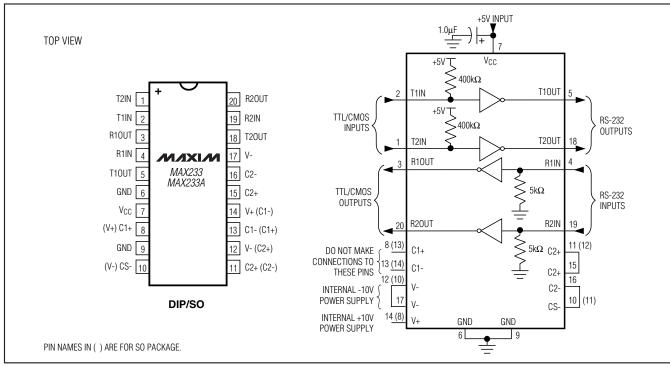


Figure 11. MAX233/MAX233A Pin Configuration and Typical Operating Circuit

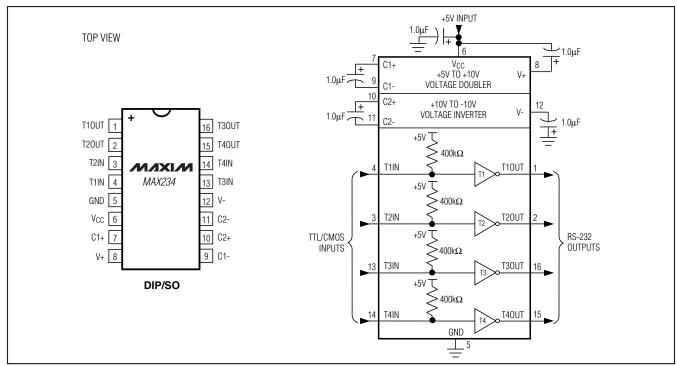


Figure 12. MAX234 Pin Configuration and Typical Operating Circuit



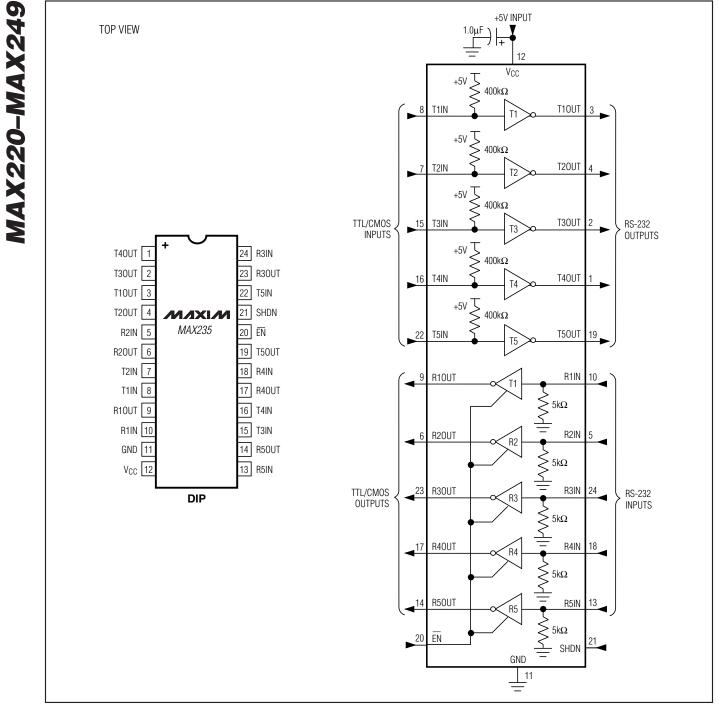


Figure 13. MAX235 Pin Configuration and Typical Operating Circuit

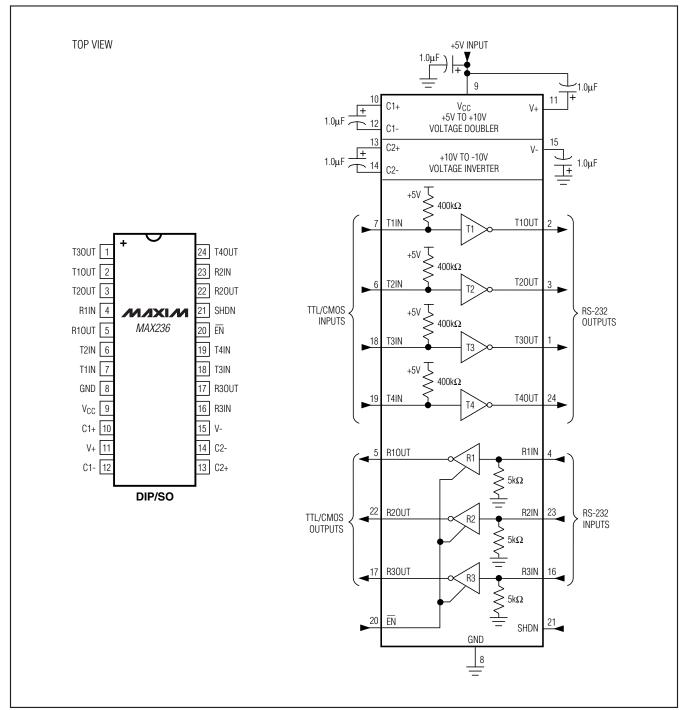


Figure 14. MAX236 Pin Configuration and Typical Operating Circuit

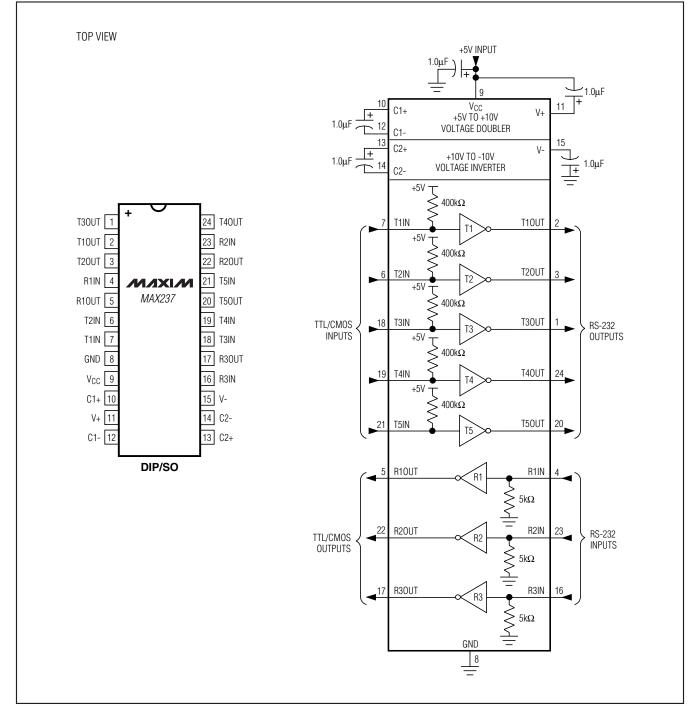


Figure 15. MAX237 Pin Configuration and Typical Operating Circuit

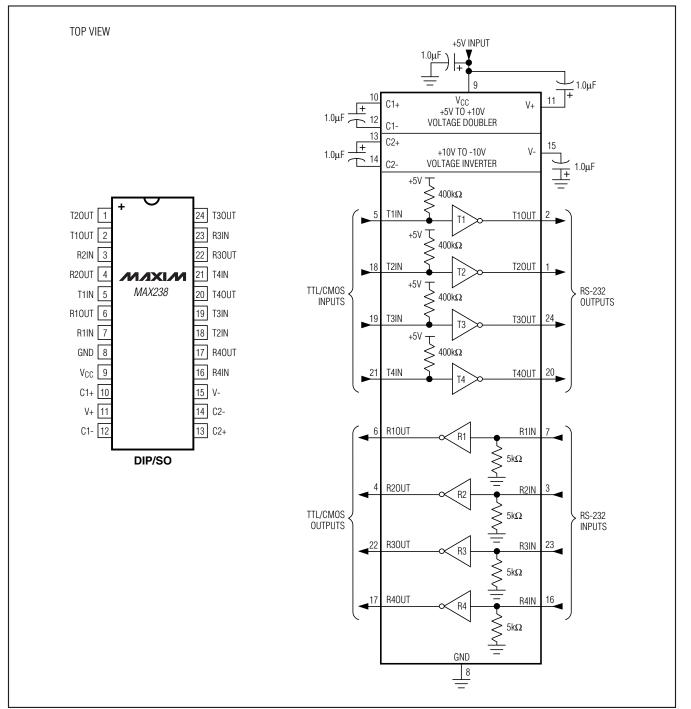


Figure 16. MAX238 Pin Configuration and Typical Operating Circuit

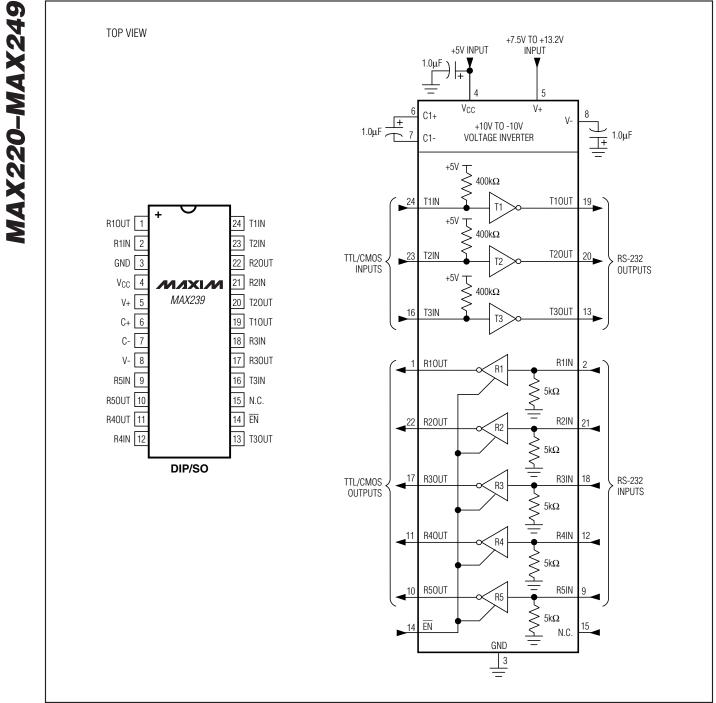


Figure 17. MAX239 Pin Configuration and Typical Operating Circuit

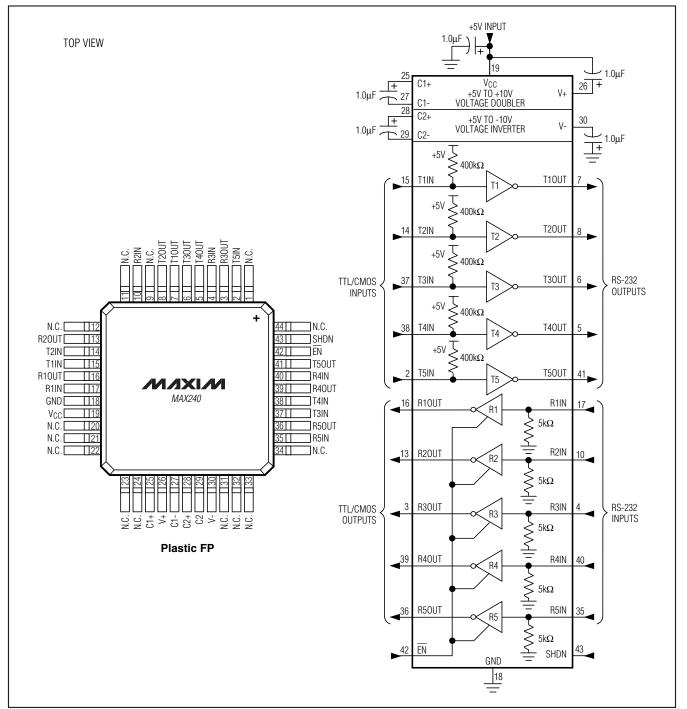


Figure 18. MAX240 Pin Configuration and Typical Operating Circuit

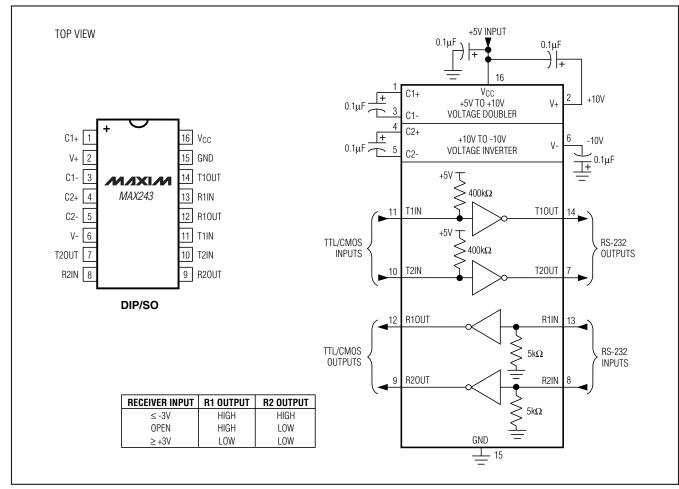


Figure 19. MAX243 Pin Configuration and Typical Operating Circuit

+5V TOP VIEW 1μF | |+ 1μF 20 C1+ Vcc TA40UT TA30UT TA20UT TA10UT TB10UT TB20UT TB30UT TB40UT RB5IN C1-+5V TO +10V VOLTAGE DOUBLER V+ RA4IN RA5IN 24 C2+ V-1µF 1uF 4 3 2 1 44 43 42 41 40 25 6 5 C2-+10V TO -10V VOLTAGE INVERTER + TA10UT -5V TB10UT J+2N + $\leq_{400k\Omega} \geq$ 15 TA1IN TB1IN 30 39 RB4IN RA3IN 7 38 RB3IN RA2IN 8 TA20UT TB20UT 2 43 RA1IN [37 RB2IN 9 400kO 36 RB1IN RA10UT 10 16 TA2IN TB2IN 29 RA20UT 11 35 RB10UT MAX244 TB30UT RA30UT 12 34 RB20UT TA30UT 42 3 RA40UT 13 33 RB30UT 17 TA3IN TB3IN 28 RA50UT 14 32 RB40UT 31 RB50UT TA1IN 15 ₹+5V -5V TB40UT TA40UT 4 41 TA2IN 16 30 TB1IN TA3IN 17 29 TB2IN 18 TA4IN TB4IN 27 9 RA1IN RB1IN 36 18 19 20 21 22 23 24 25 26 27 28 GND Vcc C1+ C1+ C2+ C2+ C2-C2-A4IN FB4IN FB3IN \geq $5k\Omega$ $5k\Omega$ PLCC 10 RA10UT RB10UT 35 8 RA2IN RB2IN 37 \leq 5kO 5kQ **MAX249 FUNCTIONAL DESCRIPTION 10 RECEIVERS** RA20UT RB20UT 11 34 **5 A-SIDE RECEIVERS** 7 **RA3IN RB3IN** 38 **5 B-SIDE RECEIVERS 8 TRANSMITTERS** $5 k\Omega$ $5k\Omega$ **4 A-SIDE TRANSMITTERS 4 B-SIDE TRANSMITTERS** 12 RA30UT RB3OUT 33 _ NO CONTROL PINS RA4IN RB4IN 6 39 \leq 5kΩ $5k\Omega$ 13 RA40UT RB40UT 32 RA5IN RB5IN 40 5 $5k\Omega$. 5kΩ RA50UT RB50UT 14 31 GND

+5V-Powered, Multichannel RS-232 Drivers/Receivers

Figure 20. MAX244 Pin Configuration and Typical Operating Circuit

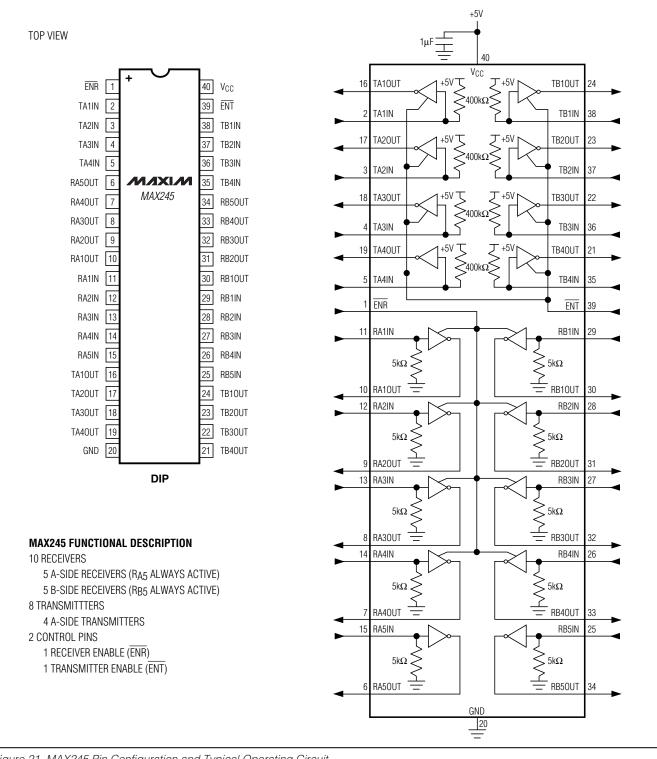


Figure 21. MAX245 Pin Configuration and Typical Operating Circuit



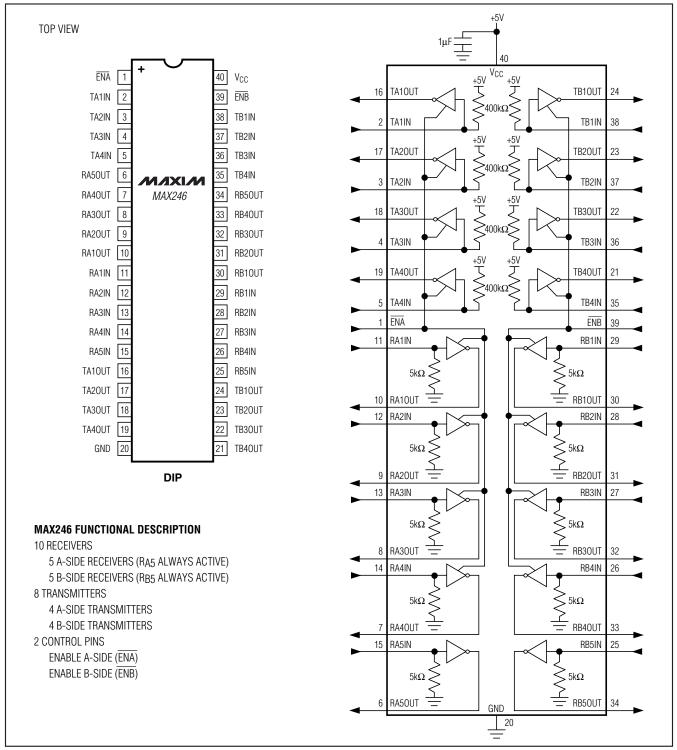


Figure 22. MAX246 Pin Configuration and Typical Operating Circuit

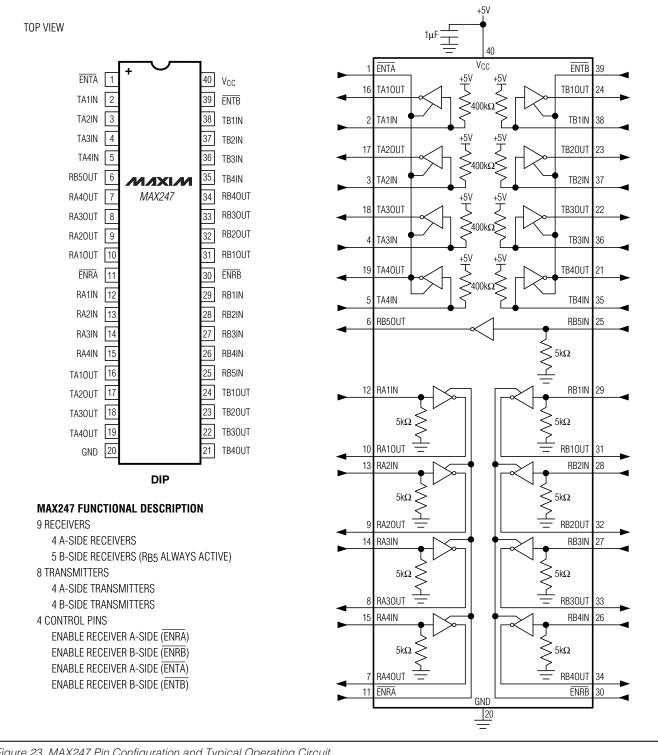


Figure 23. MAX247 Pin Configuration and Typical Operating Circuit



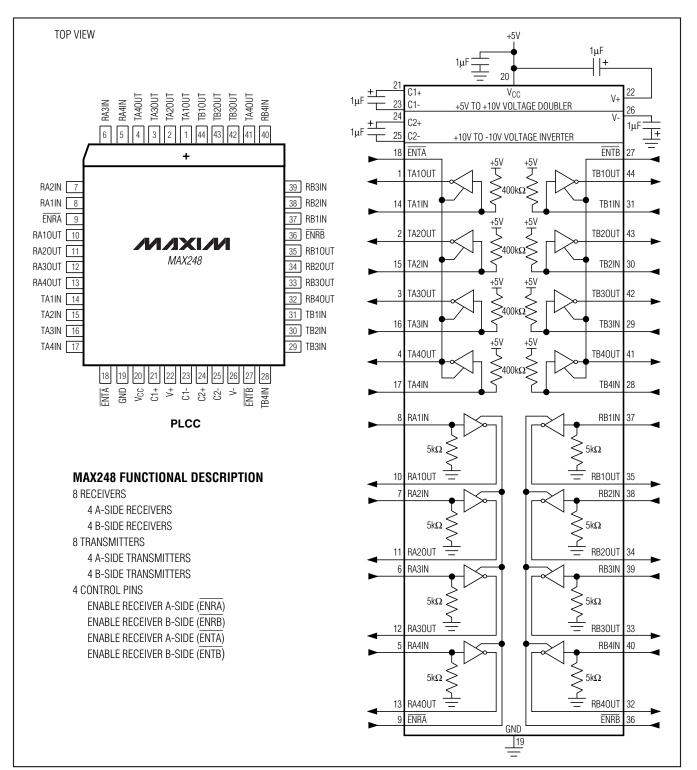


Figure 24. MAX248 Pin Configuration and Typical Operating Circuit



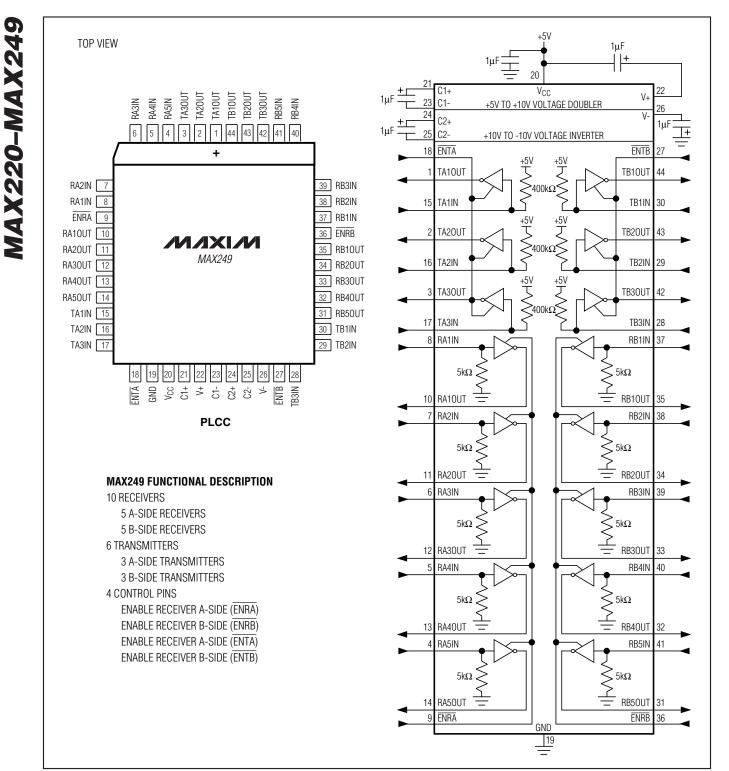


Figure 25. MAX249 Pin Configuration and Typical Operating Circuit

PART	TEMP RANGE	PIN-PACKAGE
MAX222CPN+	0°C to +70°C	18 Plastic DIP
MAX222CWN+	0°C to +70°C	18 Wide SO
MAX222C/D	0°C to +70°C	Dice*
MAX222EPN+	-40°C to +85°C	18 Plastic DIP
MAX222EWN+	-40°C to +85°C	18 Wide SO
MAX222EJN	-40°C to +85°C	18 CERDIP
MAX222MJN	-55°C to +125°C	18 CERDIP
MAX223CAI+	0°C to +70°C	28 SSOP
MAX223CWI+	0°C to +70°C	28 Wide SO
MAX223C/D	0°C to +70°C	Dice*
MAX223EAI+	-40°C to +85°C	28 SSOP
MAX223EWI+	-40°C to +85°C	28 Wide SO
MAX225CWI+	0°C to +70°C	28 Wide SO
MAX225EWI+	-40°C to +85°C	28 Wide SO
MAX230CPP+	0°C to +70°C	20 Plastic DIP
MAX230CWP+	0°C to +70°C	20 Wide SO
MAX230C/D	0°C to +70°C	Dice*
MAX230EPP+	-40°C to +85°C	20 Plastic DIP
MAX230EWP+	-40°C to +85°C	20 Wide SO
MAX230EJP	-40°C to +85°C	20 CERDIP
MAX230MJP	-55°C to +125°C	20 CERDIP
MAX231CPD+	0°C to +70°C	14 Plastic DIP
MAX231CWE+	0°C to +70°C	16 Wide SO
MAX231CJD	0°C to +70°C	14 CERDIP
MAX231C/D	0°C to +70°C	Dice*
MAX231EPD+	-40°C to +85°C	14 Plastic DIP
MAX231EWE+	-40°C to +85°C	16 Wide SO
MAX231EJD	-40°C to +85°C	14 CERDIP
MAX231MJD	-55°C to +125°C	14 CERDIP
MAX232CPE+	0°C to +70°C	16 Plastic DIP
MAX232CSE+	0°C to +70°C	16 Narrow SO
MAX232CWE+	0°C to +70°C	16 Wide SO
MAX232C/D	0°C to +70°C	Dice*
MAX232EPE+	-40°C to +85°C	16 Plastic DIP
MAX232ESE+	-40°C to +85°C	16 Narrow SO
MAX232EWE+	-40°C to +85°C	16 Wide SO
MAX232EJE	-40°C to +85°C	16 CERDIP
MAX232MJE	-55°C to +125°C	16 CERDIP
MAX232MLP+	-55°C to +125°C	20 LCC
MAX232ACPE+	0°C to +70°C	16 Plastic DIP
MAX232ACSE+	0°C to +70°C	16 Narrow SO
MAX232ACWE+	0°C to +70°C	16 Wide SO

Ordering Information (continued)

DADT		
		PIN-PACKAGE
MAX232AC/D	0°C to +70°C	Dice*
MAX232AEPE+	-40°C to +85°C	16 Plastic DIP
MAX232AESE+	-40°C to +85°C	16 Narrow SO
MAX232AEWE+	-40°C to +85°C	16 Wide SO
MAX232AEJE	-40°C to +85°C	16 CERDIP
MAX232AMJE	-55°C to +125°C	16 CERDIP
MAX232AMLP+	-55°C to +125°C	20 LCC
MAX233CPP+	0°C to +70°C	20 Plastic DIP
MAX233EPP+	-40°C to +85°C	20 Plastic DIP
MAX233ACPP+	0°C to +70°C	20 Plastic DIP
MAX233ACWP+	0°C to +70°C	20 Wide SO
MAX233AEPP+	-40°C to +85°C	20 Plastic DIP
MAX233AEWP+	-40°C to +85°C	20 Wide SO
MAX234CPE+	0°C to +70°C	16 Plastic DIP
MAX234CWE+	0°C to +70°C	16 Wide SO
MAX234C/D	0°C to +70°C	Dice*
MAX234EPE+	-40°C to +85°C	16 Plastic DIP
MAX234EWE+	-40°C to +85°C	16 Wide SO
MAX234EJE	-40°C to +85°C	16 CERDIP
MAX234MJE	-55°C to +125°C	16 CERDIP
MAX235CPG+	0°C to +70°C	24 Wide Plastic DIP
MAX235EPG+	-40°C to +85°C	24 Wide Plastic DIP
MAX235EDG	-40°C to +85°C	24 Ceramic SB
MAX235MDG	-55°C to +125°C	24 Ceramic SB
MAX236CNG+	0°C to +70°C	24 Narrow Plastic DIP
MAX236CWG+	0°C to +70°C	24 Wide SO
MAX236C/D	0°C to +70°C	Dice*
MAX236ENG+	-40°C to +85°C	24 Narrow Plastic DIP
MAX236EWG+	-40°C to +85°C	24 Wide SO
MAX236ERG	-40°C to +85°C	24 Narrow CERDIP
MAX236MRG	-55°C to +125°C	24 Narrow CERDIP
MAX237CNG+	0°C to +70°C	24 Narrow Plastic DIP
MAX237CWG+	0°C to +70°C	24 Wide SO
MAX237C/D	0°C to +70°C	Dice*
MAX237ENG+	-40°C to +85°C	24 Narrow Plastic DIP
MAX237EWG+	-40°C to +85°C	24 Wide SO
MAX237ERG	-40°C to +85°C	24 Narrow CERDIP
MAX237MRG	-55°C to +125°C	24 Narrow CERDIP
MAX238CNG+	0°C to +70°C	24 Narrow Plastic DIP
MAX238CWG+	0°C to +70°C	24 Wide SO
MAX238C/D	0°C to +70°C	Dice*
	00000	2100

+Denotes a lead(Pb)-free/RoHS-compliant package. *Contact factory for dice specifications. **MAX220-MAX249**

TEMP RANGE	PIN-PACKAGE
-40°C to +85°C	24 Narrow Plastic DIP
-40°C to +85°C	24 Wide SO
-40°C to +85°C	24 Narrow CERDIP
-55°C to +125°C	24 Narrow CERDIP
0°C to +70°C	24 Narrow Plastic DIP
0°C to +70°C	24 Wide SO
0°C to +70°C	Dice*
-40°C to +85°C	24 Narrow Plastic DIP
-40°C to +85°C	24 Wide SO
-40°C to +85°C	24 Narrow CERDIP
-55°C to +125°C	24 Narrow CERDIP
0°C to +70°C	44 Plastic FP
0°C to +70°C	Dice*
0°C to +70°C	28 SSOP
0°C to +70°C	28 Wide SO
0°C to +70°C	Dice*
-40°C to +85°C	28 SSOP
-40°C to +85°C	28 Wide SO
0°C to +70°C	20 SSOP
0°C to +70°C	18 Plastic DIP
0°C to +70°C	18 Wide SO
0°C to +70°C	Dice*
-40°C to +85°C	18 Plastic DIP
-40°C to +85°C	18 Wide SO
-40°C to +85°C	18 CERDIP
-55°C to +125°C	18 CERDIP
	$\begin{array}{c} -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -55^{\circ}\text{C to } +125^{\circ}\text{C} \\ 0^{\circ}\text{C to } +70^{\circ}\text{C} \\ 0^{\circ}\text{C to } +70^{\circ}\text{C} \\ 0^{\circ}\text{C to } +70^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +70^{\circ}\text{C} \\ 0^{\circ}\text{C to } +70^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ 0^{\circ}\text{C to } +70^{\circ}\text{C} \\ -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ \end{array}$

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX243CPE+	0°C to +70°C	16 Plastic DIP
MAX243CSE+	0°C to +70°C	16 Narrow SO
MAX243CWE+	0°C to +70°C	16 Wide SO
MAX243C/D	0°C to +70°C	Dice*
MAX243EPE+	-40°C to +85°C	16 Plastic DIP
MAX243ESE+	-40°C to +85°C	16 Narrow SO
MAX243EWE+	-40°C to +85°C	16 Wide SO
MAX243EJE	-40°C to +85°C	16 CERDIP
MAX243MJE	-55°C to +125°C	16 CERDIP
MAX244CQH+	0°C to +70°C	44 PLCC
MAX244C/D	0°C to +70°C	Dice*
MAX244EQH+	-40°C to +85°C	44 PLCC
MAX245CPL+	0°C to +70°C	40 Plastic DIP
MAX245C/D	0°C to +70°C	Dice*
MAX245EPL+	-40°C to +85°C	40 Plastic DIP
MAX246CPL+	0°C to +70°C	40 Plastic DIP
MAX246C/D	0°C to +70°C	Dice*
MAX246EPL+	-40°C to +85°C	40 Plastic DIP
MAX247CPL+	0°C to +70°C	40 Plastic DIP
MAX247C/D	0°C to +70°C	Dice*
MAX247EPL+	-40°C to +85°C	40 Plastic DIP
MAX248CQH+	0°C to +70°C	44 PLCC
MAX248C/D	0°C to +70°C	Dice*
MAX248EQH+	-40°C to +85°C	44 PLCC
MAX249CQH+	0°C to +70°C	44 PLCC
MAX249EQH+	-40°C to +85°C	44 PLCC

+Denotes a lead(Pb)-free/RoHS-compliant package. *Contact factory for dice specifications.

Package Information

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO	
14 PDIP	P14+3			
16 PDIP	P16+1			
16 PDIP	P16+2			
16 PDIP	P16+3	<u>21-0043</u>		
18 PDIP	P18+5			
20 PDIP	P20+3			
20 PDIP	P20M+1			
24 PDIP	N24+3			
24 PDIP	P24M+1		—	
28 PDIP	P28+2	04 0044		
40 PDIP	P40+1	<u>21-0044</u>		
40 PDIP	P40M+2			
14 CERDIP	J14-3			
16 CERDIP	J16-3			
18 CERDIP	J18-2	<u>21-0045</u>		
20 CERDIP	J20-2			
24 CERDIP	R24-4			
16 SO(N)	S16+3	01 00 11	00.0007	
16 SO(N)	S16+5	<u>21-0041</u>	<u>90-0097</u>	
16 SO(W)	W16+1		<u>90-0107</u>	
16 SO(W)	W16+2			
16 SO(W)	W16+3			
18 SO(W)	W18+1		<u>90-0181</u>	
20 SO(W)	W20+3		00.0100	
20 SO(W)	W20M+1	<u>21-0042</u>	<u>90-0108</u>	
24 SO(W)	W24+2		<u>90-0182</u>	
28 SO(W)	W28+1		<u>90-0109</u>	
28 SO(W)	W28+2			
28 SO(W)	W28M+1			
20 LCC	L20+3	<u>21-0658</u>	<u>90-0177</u>	
20 SSOP	A20+1		<u>90-0094</u>	
24 SSOP	A24+2		<u>90-0110</u>	
28 SSOP	A28+1	<u>21-0056</u>	<u>90-0095</u>	
16 TSSOP	U16+1		<u>90-0117</u>	
16 FPCK	F16-3	<u>21-0013</u>	_	
44 MQFP	M44+5	<u>21-0826</u>	<u>90-0169</u>	
44 PLCC	Q44+1	01.0040	00.0000	
44 PLCC	Q44+2	<u>21-0049</u>	<u>90-0236</u>	

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
15	1/06	Added part information to the lead temperature in the Absolute Maximum Ratings sections	2, 5, 8
16	7/10	Changed multiple packages to lead-free versions; updated/added notes 3, 4, 5, 7, and 8 to the <i>Electrical Characteristics</i> table; removed incorrect subscripting from all pin names in the <i>Electrical Characteristics</i> table and <i>Pin Configurations</i>	1, 2–9, 17–36

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